IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composi © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	all rights reserved un										if the item is an a er has engineering	
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier Informa	ation														
Company name*			Company unique ID			U	Unique ID Authority					Response Date*			
nsemi											2024-05-06				
Contact Name		Title - Contact			P	Phone - Contact*					Email - Contact*				
Product-Env-Stewar	rds	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
uthorized Represen	ntative*	Title - Representative			P	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Requester	ester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	Date Version Manufacturing Site		V	Veight*	UOM	Unit Type		
				1PH DRV SENSO driver with hall sen speed control))6				1	30.0	mg	Each
Ianufacturing P	Proccess Information	n													
Terminal P	Terminal Plating / Grid Array Material		Terminal Base Alloy J-ST		STD-020 MSL R	Rating	Peak Process Body Ter		y Temperat	emperature Max Time at Peak		Temperatu	re Num	ber of Reflow Cy	cles
contains Bi			CU Alloy 3				260 C 30			seconds 3					
omments															
TTENTION: MSL	3 Rated item requires Ba	ake and D	ry Pack (after	electrical test)											
	on regarding material con														

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.45	mg	Supplier	Silicon (Si)	7440-21-3		3.4245	mg
			Supplier	Polyimide	Proprietary Data		0.0255	mg
Die Attach	0.7	mg	Supplier	Silver (Ag)	7440-22-4		0.497	mg
			Supplier	Epoxy resins	129915-35-1		0.203	mg
Lead Frame	17.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.0323	mg
			Supplier	Iron (Fe)	7439-89-6		0.4403	mg
			Supplier	Copper (Cu)	7440-50-8		16.5036	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0238	mg
Mold Compound-Black	106.9	mg		Epoxy Phenol Resin	proprietary data		12.828	mg
			Supplier	Carbon Black (C)	1333-86-4		0.4276	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		90.4374	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3.207	mg
Plating	1.8	mg	В	Bismuth (Bi)	7440-69-9		0.0108	mg
			Supplier	Tin (Sn)	7440-31-5		1.7892	mg
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg